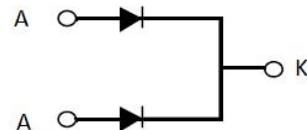
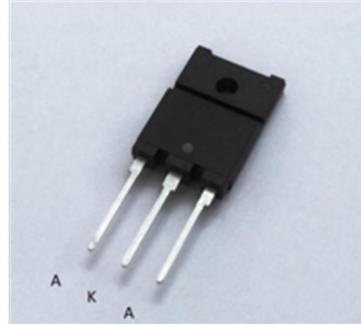


FRED
Ultrafast Soft Recovery Diode, 16A

Features:

- Ultrafast Recovery
- 175°C operating junction temperature
- High frequency operation
- Low power loss, less RFI and EMI
- Low I_R value
- High surge capacity
- Epitaxial chip construction



Product Summary	
V_R	1200 V
$I_F(AV)$	2*8A
t_{rr}	25ns

Description/Applications

These diodes are optimized to less losses and EMI/RFI in high frequency power conditioning system. The soft recovery behavior of the diodes. These devices are ideally suited for applications where the switching losses are not significant portion of the total losses.

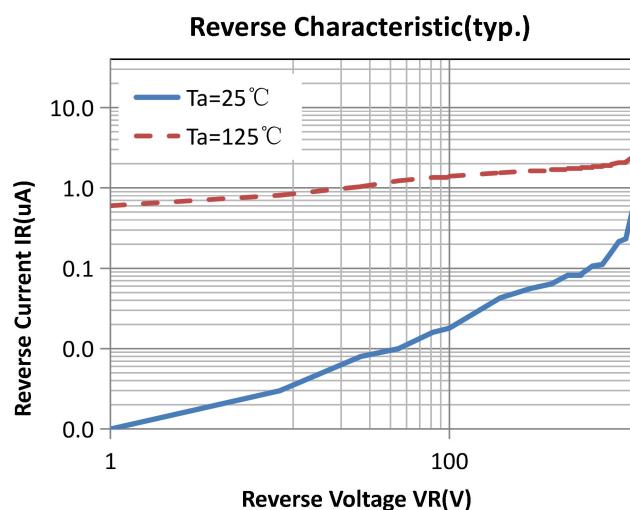
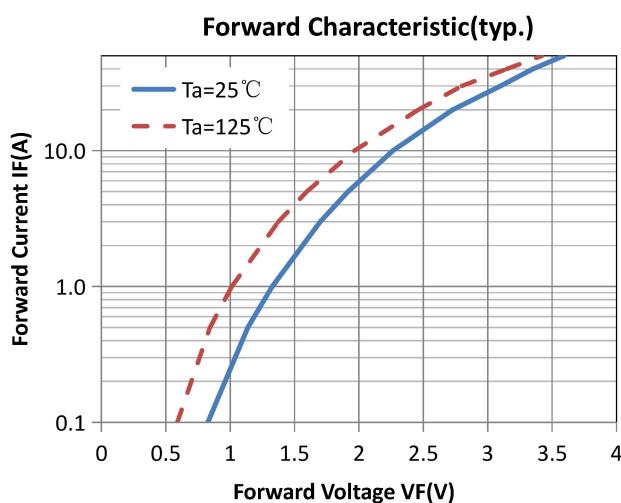
Absolute Maximum Ratings				
Parameter	Symbol	Test Conditions	Values	Units
Repetitive peak reverse voltage	V_{RRM}		1200	V
Continuous forward current	$I_F(AV)$	$T_c = 110^\circ C$	16	A
Single pulse forward current	I_{FSM}	$T_c = 25^\circ C$	64	
Maximum repetitive forward current	I_{FRM}	Square wave, 20kHz	10	
Operating junction	T_j		175	°C
Storage temperatures	T_{stg}		-55 to +175	°C

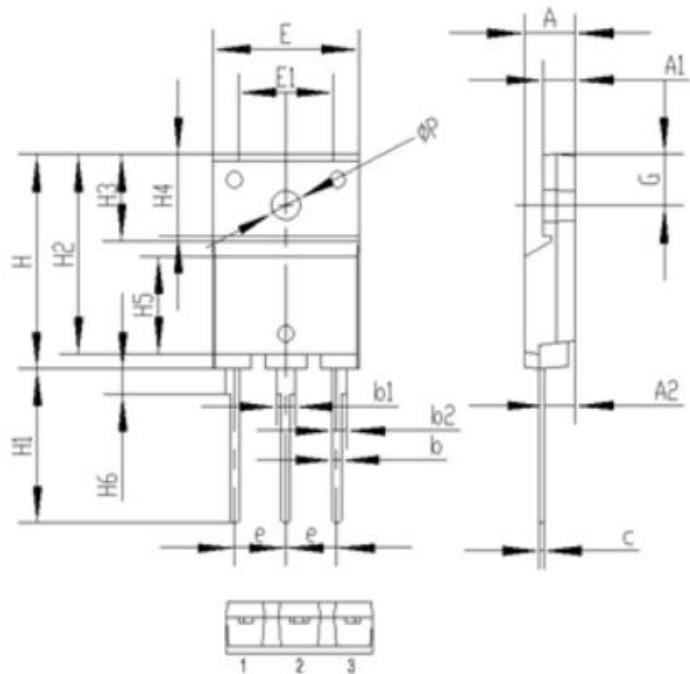
Electrical characteristics (Ta=25°C unless otherwise specified)						
Parameter	Symbol	Test Conditions	Min	Typ.	Max.	Units
Breakdown voltage Blocking voltage	V _{BR} , V _R	I _R =100μA	1200			V
Forward voltage (Per Diode)	V _F	I _F =8A		2.10	2.70	
		I _F =8A, T _j =125°C		1.95	2.50	
Reverse leakage current(Per Diode)	I _R	V _R =V _{RRM}			20	μA
		T _j =150°C, V _R =1200V			200	
Reverse recovery time(Per Diode)	t _{rr}	I _F =0.5A, I _R =1A, I _{RR} =0.25A		40	50	ns
		I _F =1A, V _R =30V, di/dt=200A/us		25	35	

Thermal characteristics

Paramter	Symbol	Typ	Units
Junction-to-Case	R _{θJC}	0.8	°C/W

Electrical performance (typic)



Package Information**TO-3PF PACKAGE**

Symbol	Dimensions(millimeters)	
	Min.	Max.
A	5.30	5.70
A1	3.25	3.65
A2	3.15	3.55
b	0.80	1.20
b1	1.85	2.15
b2	1.45	1.75
c	0.40	0.80
e	5.25	5.65
E	15.4	15.8
E1	10.0	10.4
H	22.5	23.2
H1	16.0	17.0
H2	21.2	21.6
H3	9.10	9.50
H4	8.55	8.95
H5	10.20	10.60
H6	2.55	2.85
G	5.30	5.70
ΦP	3.00	3.40